

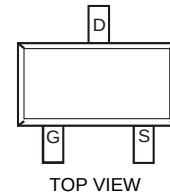
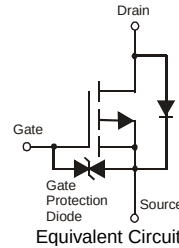
## Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **Lead Free By Design/RoHS Compliant (Note 2)**
- **ESD Protected Gate**
- **"Green" Device (Note 4)**
- **Qualified to AEC-Q101 standards for High Reliability**

## Mechanical Data

- Case: SOT-523
- Case Material: Molded Plastic, "Green" Molding Compound.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish - Matte Tin annealed over Alloy 42 Leadframe.  
Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.002 grams (approximate)

SOT-523



## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                | Symbol           | Value | Units |
|-------------------------------|------------------|-------|-------|
| Drain-Source Voltage          | V <sub>DSS</sub> | -20   | V     |
| Gate-Source Voltage           | V <sub>GSS</sub> | ±8    | V     |
| Drain Current (Note 1)        | I <sub>D</sub>   | -430  | mA    |
| Steady State                  |                  | -310  | mA    |
| Pulsed Drain Current (Note 3) | I <sub>DM</sub>  | -750  | mA    |

## Thermal Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                          | Symbol                            | Value       | Units |
|-----------------------------------------|-----------------------------------|-------------|-------|
| Total Power Dissipation (Note 1)        | P <sub>D</sub>                    | 150         | mW    |
| Thermal Resistance, Junction to Ambient | R <sub>θJA</sub>                  | 833         | °C/W  |
| Operating and Storage Temperature Range | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C    |

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

| Characteristic                      | Symbol              | Min  | Typ | Max  | Unit | Test Condition                                              |
|-------------------------------------|---------------------|------|-----|------|------|-------------------------------------------------------------|
| <b>OFF CHARACTERISTICS (Note 5)</b> |                     |      |     |      |      |                                                             |
| Drain-Source Breakdown Voltage      | BV <sub>DSS</sub>   | -20  | —   | —    | V    | V <sub>GS</sub> = 0V, I <sub>D</sub> = -250mA               |
| Zero Gate Voltage Drain Current     | I <sub>DSS</sub>    | —    | —   | -1.0 | μA   | V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V                |
| Gate-Source Leakage                 | I <sub>GSS</sub>    | —    | —   | ±1.0 | μA   | V <sub>GS</sub> = ±4.5V, V <sub>DS</sub> = 0V               |
| <b>ON CHARACTERISTICS (Note 5)</b>  |                     |      |     |      |      |                                                             |
| Gate Threshold Voltage              | V <sub>GS(th)</sub> | -0.5 | —   | -1.0 | V    | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250μA |
| Static Drain-Source On-Resistance   | R <sub>DS(on)</sub> | —    | 0.7 | 1.1  | Ω    | V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -430mA            |
|                                     |                     |      | 1.1 | 1.6  |      | V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -300mA            |
|                                     |                     |      | 1.7 | 2.6  |      | V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -150mA            |
| Forward Transfer Admittance         | Y <sub>fs</sub>     | 200  | —   | —    | ms   | V <sub>DS</sub> = 10V, I <sub>D</sub> = 0.2A                |
| Diode Forward Voltage (Note 5)      | V <sub>SD</sub>     | —    | —   | -1.4 | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = -115mA               |
| <b>DYNAMIC CHARACTERISTICS</b>      |                     |      |     |      |      |                                                             |
| Input Capacitance                   | C <sub>iss</sub>    | —    | —   | 175  | pF   | V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V<br>f = 1.0MHz  |
| Output Capacitance                  | C <sub>oss</sub>    | —    | —   | 30   | pF   |                                                             |
| Reverse Transfer Capacitance        | C <sub>rss</sub>    | —    | —   | 20   | pF   |                                                             |

- Notes:
1. Device mounted on FR-4 PCB.
  2. No purposefully added lead.
  3. Pulse width ≤10μs, Duty Cycle ≤1%
  4. Diodes Inc.'s "Green" policy can be found on our website at [http://www.diodes.com/products/lead\\_free/index.php](http://www.diodes.com/products/lead_free/index.php).
  5. Short duration pulse test used to minimize self-heating effect.

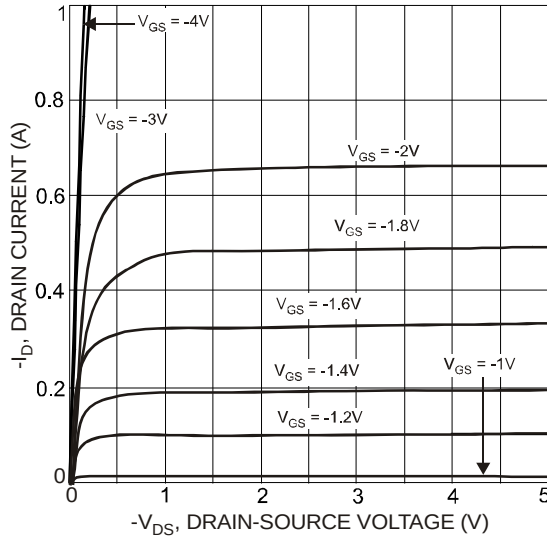


Fig. 1 Typical Output Characteristics

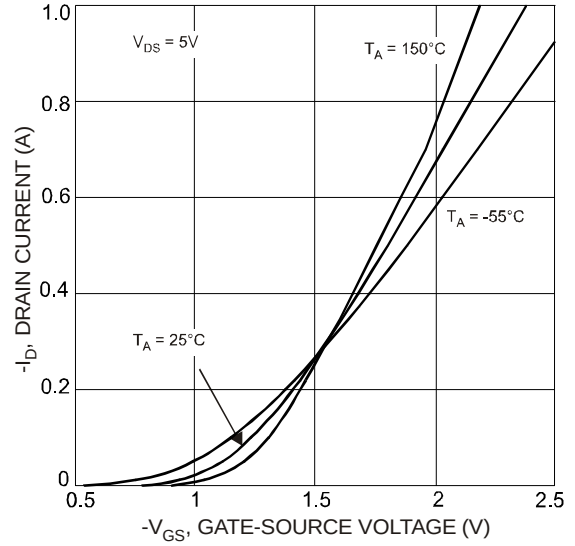


Fig. 2 Typical Transfer Characteristics

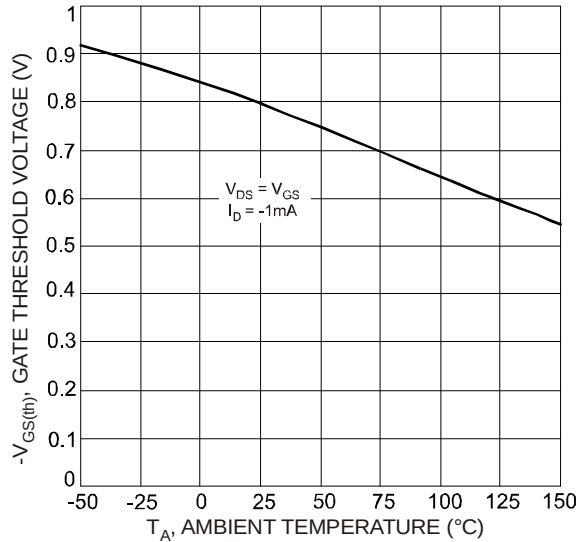


Fig. 3 Gate Threshold Voltage vs. Ambient Temperature

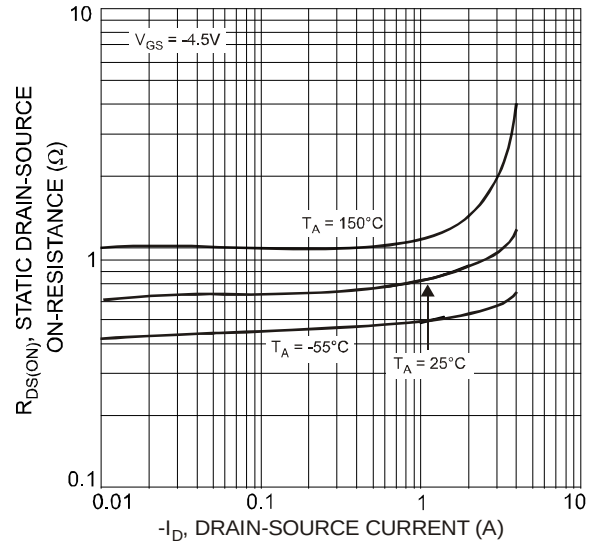


Fig. 4 Static Drain-Source On-Resistance vs. Drain Current

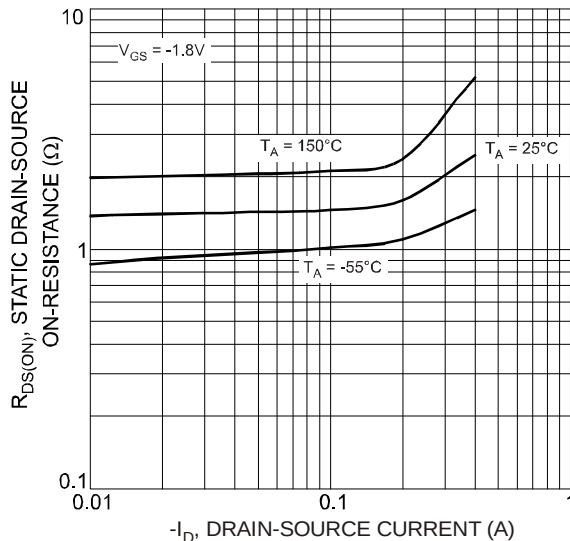


Fig. 5 Static Drain-Source On-Resistance vs. Drain Current

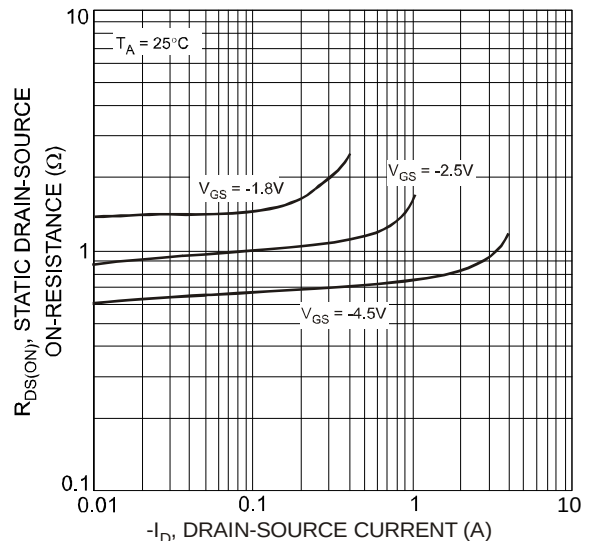
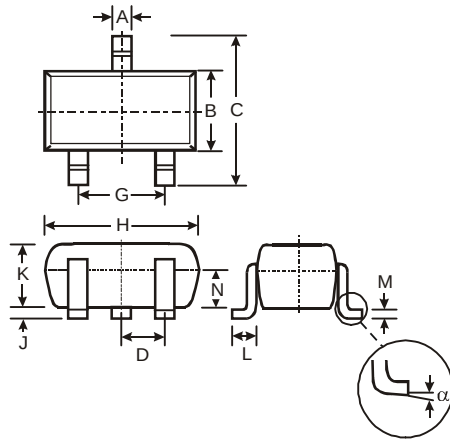


Fig. 6 Static Drain-Source On-Resistance vs. Drain-Source Current

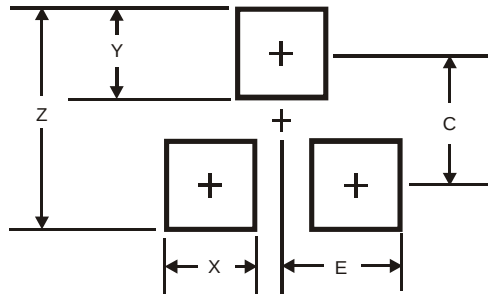


## Package Outline Dimensions



| SOT-523              |      |      |      |
|----------------------|------|------|------|
| Dim                  | Min  | Max  | Typ  |
| A                    | 0.15 | 0.30 | 0.22 |
| B                    | 0.75 | 0.85 | 0.80 |
| C                    | 1.45 | 1.75 | 1.60 |
| D                    | —    | —    | 0.50 |
| G                    | 0.90 | 1.10 | 1.00 |
| H                    | 1.50 | 1.70 | 1.60 |
| J                    | 0.00 | 0.10 | 0.05 |
| K                    | 0.60 | 0.80 | 0.75 |
| L                    | 0.10 | 0.30 | 0.22 |
| M                    | 0.10 | 0.20 | 0.12 |
| N                    | 0.45 | 0.65 | 0.50 |
| $\alpha$             | 0°   | 8°   | —    |
| All Dimensions in mm |      |      |      |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z          | 1.8           |
| X          | 0.4           |
| Y          | 0.51          |
| C          | 1.3           |
| E          | 0.7           |

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